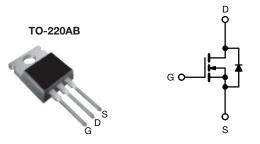
Vishay Siliconix

COMPLIANT

HALOGEN

FREE

E Series Power MOSFET



N-Channel MOSFET

PRODUCT SUMMAR	Y	
V _{DS} (V) at T _J max.	65	50
R _{DS(on)} typ. (Ω) at 25 °C	$_{0}$ typ. (Ω) at 25 °C $V_{GS} = 10 \text{ V}$ 0.	
Q _g max. (nC)	5	0
Q _{gs} (nC)	13	
Q _{gd} (nC)	1	0
Configuration	Sin	gle

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP100N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T_{C}	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	600	V	
Gate-source voltage			V_{GS}	± 30	7 v
Continuous dusin surrent /T 150 °C\	V at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	l _D	30	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C		19	A
Pulsed drain current a		I _{DM}	73		
Linear derating factor				1.67	W/°C
Single pulse avalanche energy b			E _{AS}	226	mJ
Maximum power dissipation			P_{D}	208	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$		dv/dt	100) //	
Reverse diode dv/dt d			23	- V/ns	
Soldering recommendations (peak temperature) c	For	10 s		260	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.0 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, di/dt = 100 A/ μ s, starting $T_J = 25$ °C



Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R_{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	0.6	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Onto anima lankana		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I_{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
Zana anta college durin account		V _{DS} =	V _{DS} = 600 V, V _{GS} = 0 V		-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 13 A	-	0.086	0.1	Ω
Forward transconductance a	9 _{fs}	V _{DS} = 8 V, I _D = 13 A		-	11	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		1851	-	pF
Output capacitance	C _{oss}	,			84	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}			-	64	-	
Effective output capacitance, time related ^b	C _{o(tr)}	V _{DS} = 0 \	$V_{DS} = 0 \text{ V to } 480 \text{ V, } V_{GS} = 0 \text{ V}$		407	-	
Total gate charge	Qg			-	33	50	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 13 \text{ A}, V_{DS} = 480 \text{ V}$	-	13	-	nC
Gate-drain charge	Q _{gd}	7		-	10	-	
Turn-on delay time	t _{d(on)}	$V_{DD} = 480 \text{ V}, I_{D} = 13 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	21	42	
Rise time	t _r			-	34	68	
Turn-off delay time	t _{d(off)}			-	33	66	ns
Fall time	t _f		1		20	40	
Gate input resistance	R_g	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the		-	30	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	73	- A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 13 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	358	716	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 13 \text{ A},$ $di/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	5.1	10.2	μC
Reverse recovery current	I _{RRM}			_	24	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

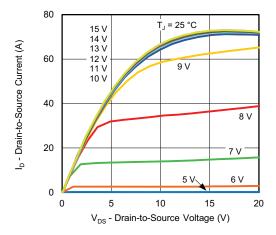


Fig. 1 - Typical Output Characteristics

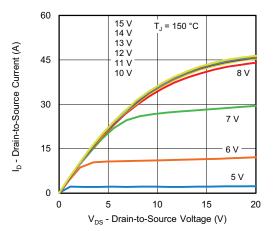


Fig. 2 - Typical Output Characteristics

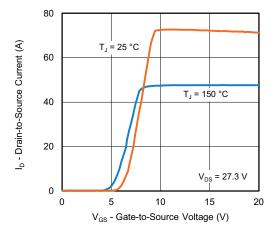


Fig. 3 - Typical Transfer Characteristics

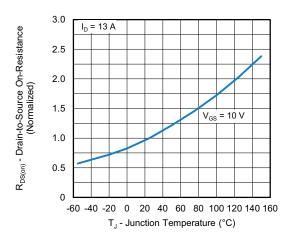


Fig. 4 - Normalized On-Resistance vs. Temperature

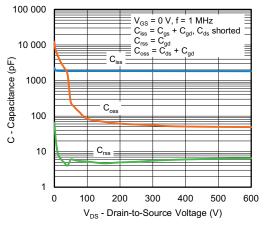


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

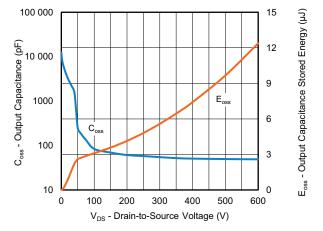


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



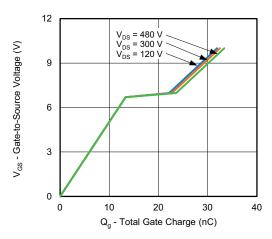


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

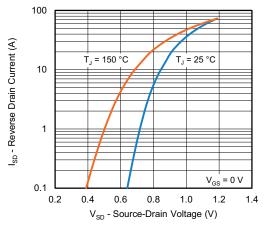


Fig. 8 - Typical Source-Drain Diode Forward Voltage

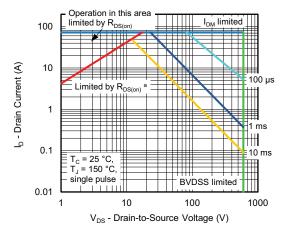


Fig. 9 - Maximum Safe Operating Area



a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

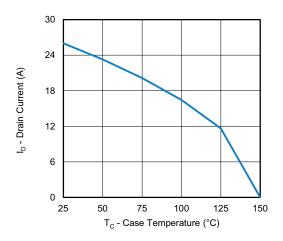


Fig. 10 - Maximum Drain Current vs. Case Temperature

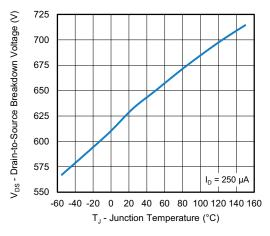


Fig. 11 - Temperature vs. Drain-to-Source Voltage



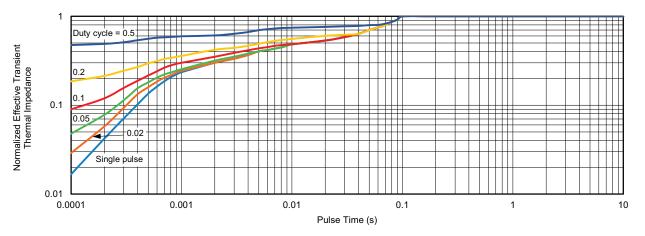


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

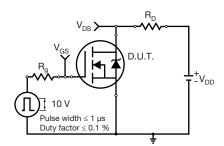


Fig. 13 - Switching Time Test Circuit

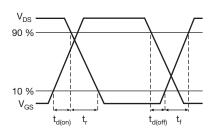


Fig. 14 - Switching Time Waveforms

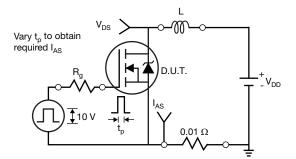


Fig. 15 - Unclamped Inductive Test Circuit

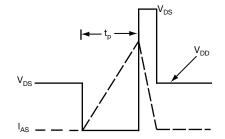


Fig. 16 - Unclamped Inductive Waveforms

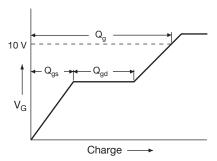


Fig. 17 - Basic Gate Charge Waveform

Current regulator
Same type as D.U.T.

12 V T0.2 μF 0.3 μF

D.U.T. T-VDS

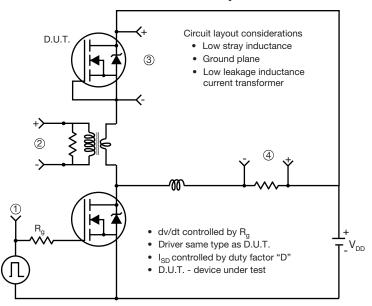
www.vishay.com

Fig. 18 - Gate Charge Test Circuit

Current sampling resistors



Peak Diode Recovery dv/dt Test Circuit



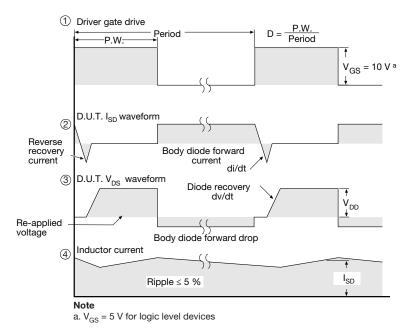


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIM	METERS	INC	CHES
	MIN.	MAX.	MIN.	MAX.
Α	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
Е	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

DWG: 6031

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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